

HAT1094C

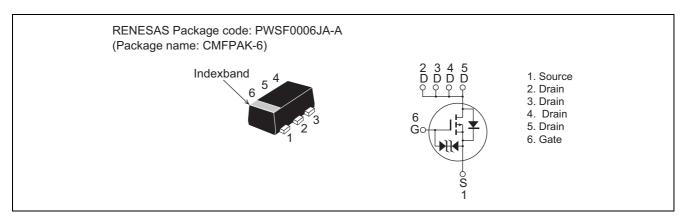
Silicon P Channel MOS FET Power Switching

REJ03G1231-0400 Rev.4.00 Feb 28, 2006

Features

- Low on-resistance $R_{DS(on)} = 67 \text{ m}\Omega \text{ typ. (at } V_{GS} = -4.5 \text{ V})$
- www.DataSheet U. Low drive current.
 - 1.8 V gate drive devices.
 - High density mounting

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	-12	V
Gate to Source voltage	V _{GSS}	±8	V
Drain current	I _D	-2.5	A
Drain peak current	I _D (pulse) ^{Note1}	-10	A
Body - Drain diode reverse drain current	I _{DR}	-2.5	A
Channel dissipation	Pch ^{Note 2}	850	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. When using the glass epoxy board. (FR4 $40 \times 40 \times 1.6$ mm), Ta = 25° C

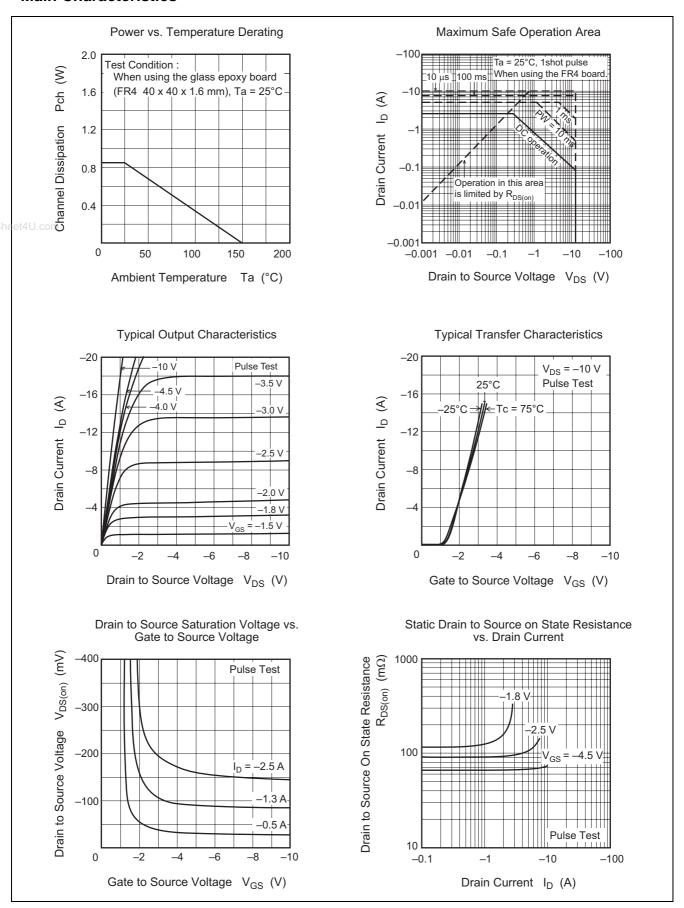
Electrical Characteristics

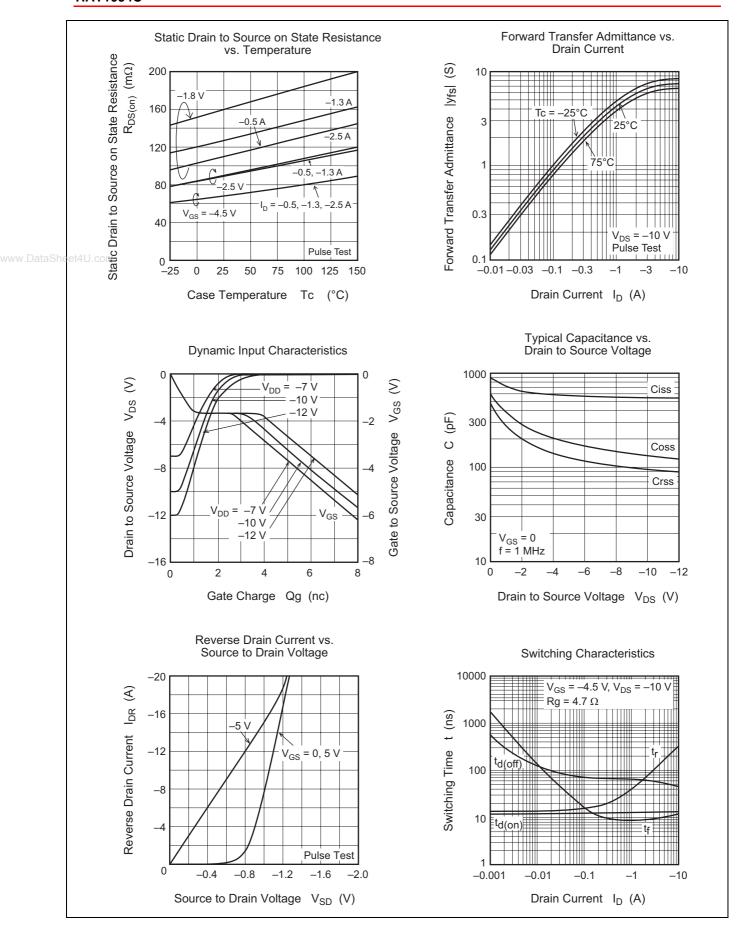
 $(Ta = 25^{\circ}C)$

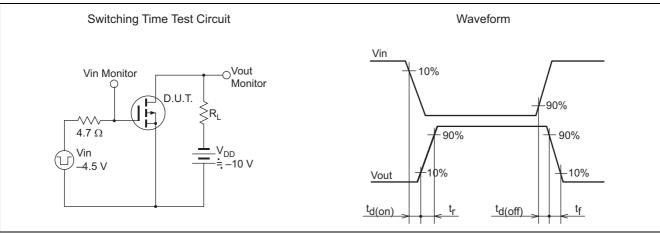
	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
	Drain to Source breakdown voltage	$V_{(BR)DSS}$	-12	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
	Gate to Source breakdown voltage	$V_{(BR)GSS}$	±8	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
	Gate to Source leakage current	I _{GSS}			±10	μΑ	$V_{GS} = \pm 6.4 \text{ V}, V_{DS} = 0$
	Drain to Source leakage current	I _{DSS}	1	1	-1	μΑ	$V_{DS} = -12 \text{ V}, V_{GS} = 0$
	Gate to Source cutoff voltage	$V_{GS(th)}$	-0.3	1	-1.2	>	$I_D = -1 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$
	Drain to Source on state resistance	R _{DS(on)}		67	88	mΩ	$I_D = -1.3 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note3}}$
				90	126	mΩ	$I_D = -1.3 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note3}}$
			_	128	192	mΩ	$I_D = -1.3 \text{ A}, V_{GS} = -1.8 \text{ V}^{\text{Note3}}$
	Forward transfer admittance	y _{fs}	3.5	5	_	S	$I_D = -1.3 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$
www.DataShe	Input capacitance	Ciss		530		pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0,$
	Output capacitance	Coss		130		pF	f = 1 MHz
	Reverse transfer capacitance	Crss		95		pF	
	Total gate charge	Qg		6.5		nC	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V},$
	Gate to Source charge	Qgs		1		nC	$I_D = -2.5 \text{ A}$
	Gate to Drain charge	Qgd		1.8		nC	
	Turn - on delay time	t _{d(on)}		12		ns	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V},$
	Rise time	t _r		52		ns	$I_D = -1.3 \text{ A}, R_L = 7.7 \Omega,$
	Turn - off delay time	$t_{\text{d(off)}}$		62		ns	$R_g = 4.7 \Omega$
	Fall time	t _f		9		ns	
	Body - Drain diode forward voltage	V_{DF}	_	-0.85	-1.1	V	$I_F = -2.5 \text{ A}, V_{GS} = 0$

Notes: 3. Pulse test

Main Characteristics

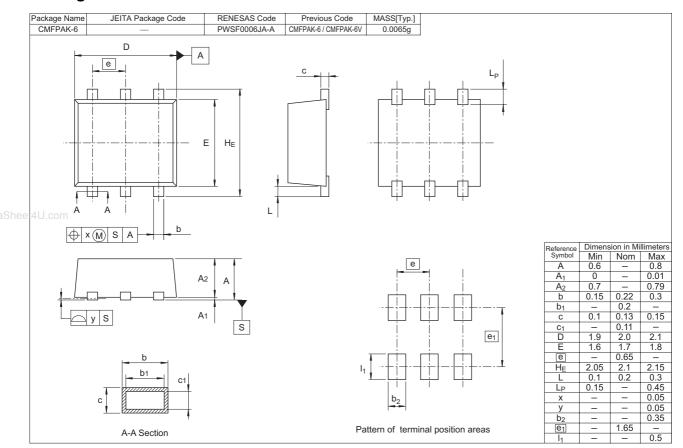






www.DataSheet4U.com

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT1094C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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